

2SB1499, 2SB1499A

Silicon PNP epitaxial planar type

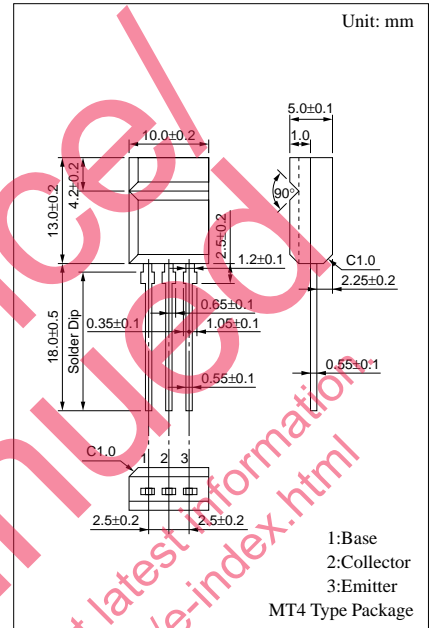
For low-frequency power amplification

Features

- High forward current transfer ratio h_{FE} which has satisfactory linearity
- Low collector to emitter saturation voltage $V_{CE(sat)}$
- Allowing automatic insertion with radial taping

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$)

Parameter	Symbol	Rated	Unit
Collector to base voltage	V_{CBO}	-60	V
2SB1499A		-80	
Collector to emitter voltage	V_{CEO}	-60	V
2SB1499A		-80	
Emitter to base voltage	V_{EBO}	-5	V
Peak collector current	I_{CP}	-8	A
Collector current	I_C	-4	A
Collector power dissipation	P_C	15	W
$T_C=25^\circ\text{C}$ $T_a=25^\circ\text{C}$		2	
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$



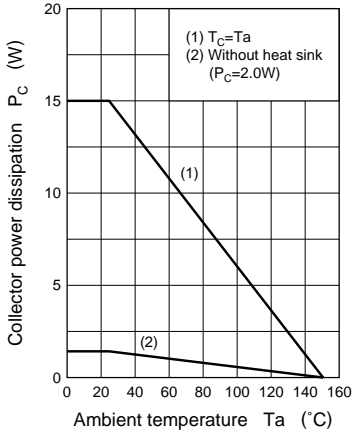
Electrical Characteristics ($T_C=25^\circ\text{C}$)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CES}	$V_{CE} = -60\text{V}, V_{BE} = 0$			-400	μA
2SB1499A		$V_{CE} = -80\text{V}, V_{BE} = 0$			-400	
Collector cutoff current	I_{CEO}	$V_{CE} = -30\text{V}, I_B = 0$			-700	μA
2SB1499A		$V_{CE} = -60\text{V}, I_B = 0$			-700	
Emitter cutoff current	I_{EBO}	$V_{EB} = -5\text{V}, I_C = 0$			-1	mA
Collector to emitter voltage	V_{CEO}	$I_C = -30\text{mA}, I_B = 0$	-60			V
2SB1499A			-80			
Forward current transfer ratio	h_{FE1}	$V_{CE} = -4\text{V}, I_C = -1\text{A}$	70		250	
	h_{FE2}	$V_{CE} = -4\text{V}, I_C = -3\text{A}$	15			
Base to emitter voltage	V_{BE}	$V_{CE} = -4\text{V}, I_C = -3\text{A}$			-2	V
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = -4\text{A}, I_B = -0.4\text{A}$			-1.5	V
Transition frequency	f_T	$V_{CE} = -10\text{V}, I_C = -0.1\text{A}, f = 10\text{MHz}$		30		MHz
Turn-on time	t_{on}	$I_C = -4\text{A}, I_{B1} = -0.4\text{A}, I_{B2} = 0.4\text{A}$		0.2		μs
Storage time	t_{stg}			0.5		μs
Fall time	t_f			0.2		μs

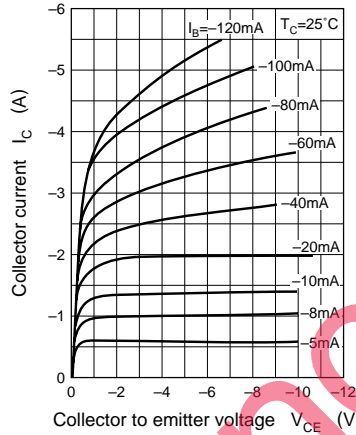
* h_{FE1} Rank classification

Rank	Q	P
h_{FE1}	70 to 150	120 to 250

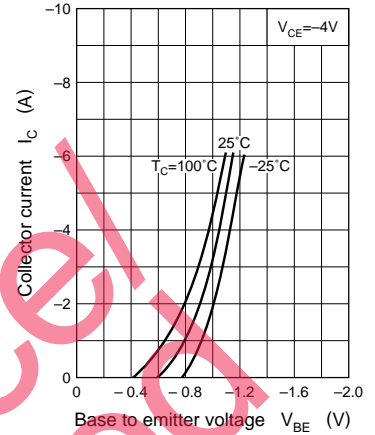
$P_C - T_a$



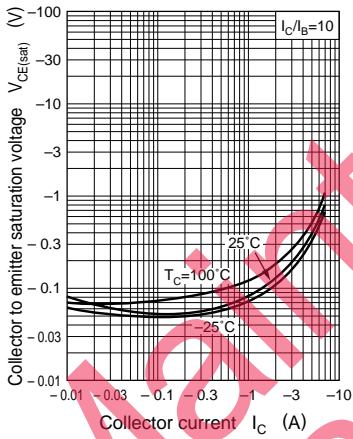
$I_C - V_{CE}$



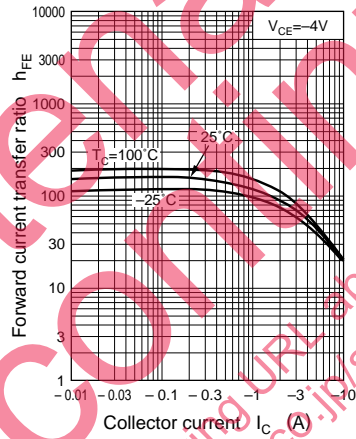
$I_C - V_{BE}$



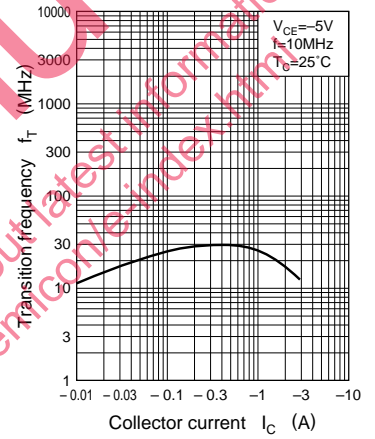
$V_{CE(sat)} - I_C$



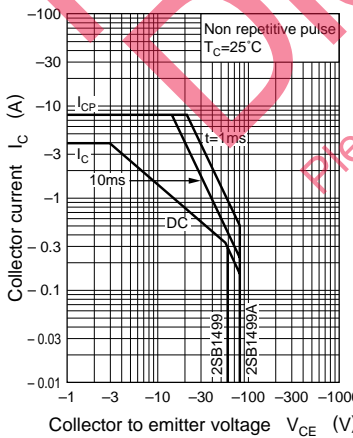
$h_{FE} - I_C$



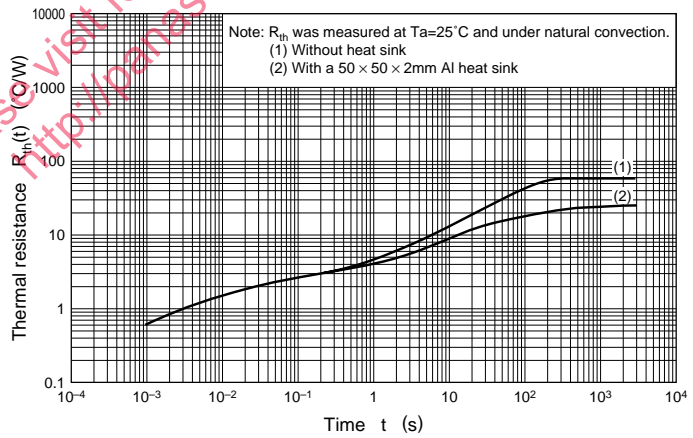
$f_T - I_C$



Area of safe operation (ASO)



$R_{th(t)} - t$



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